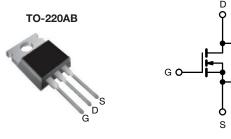
Vishay Siliconix



Configuration

D Series Power MOSFET

PRODUCT SUMMARY				
V_{DS} (V) at T_J max.	550			
R _{DS(on)} max. (Ω) at 25 °C	$V_{GS} = 10 V$	1.5		
Q _g max. (nC)	20			
Q _{gs} (nC)	3			
Q _{gd} (nC)	5			



N-Channel MOSFET

Single

FEATURES

- Optimal design
 - Low area specific on-resistance
 - Low input capacitance (Ciss)
 - Reduced capacitive switching losses
 - High body diode ruggedness
 - Avalanche energy rated (UIS)
- Optimal efficiency and operation
 - Low cost
 - Simple gate drive circuitry
 - Low figure-of-merit (FOM): Ron x Qa
 - Fast switching
- Material categorization: for definitions of compliance please see <u>www.vishay.com/doc?99912</u>

APPLICATIONS

- Consumer electronics
 - Displays (LCD or plasma TV)
- Server and telecom power supplies
 - SMPS
- Industrial
 - Welding
 - Induction heating
 - Motor drives
- Battery chargers

ORDERING INFORMATION				
Package	TO-220AB			
Lead (Pb)-free	IRF830BPbF			

ABSOLUTE MAXIMUM RATINGS (T _C = 25 °C, unless otherwise noted)					
PARAMETER	SYMBOL	LIMIT	UNIT		
Drain-Source Voltage		V _{DS}	500		
Gate-Source Voltage		N/	± 30	V	
Gate-Source Voltage AC (f > 1 Hz)		V _{GS}	30]	
Continuous Drain Current (T 150 °C)	V_{GS} at 10 V $T_C = 25 \degree C$		5.3		
Continuous Drain Current ($T_J = 150 \ ^\circ C$)	V_{GS} at 10 V $T_C = 100 \text{ °C}$	Ι _D	3.4	A	
Pulsed Drain Current ^a	I _{DM}	10]		
Linear Derating Factor		0.83	W/°C		
Single Pulse Avalanche Energy ^b	E _{AS}	28.8	mJ		
Maximum Power Dissipation	PD	104	W		
Operating Junction and Storage Temperature Range	T _J , T _{stg}	-55 to +150	°C		
Drain-Source Voltage Slope $T_J = 125 \text{ °C}$		dV/dt	24)///	
Reverse Diode dV/dt ^d	0.28		V/ns		
Soldering Recommendations (Peak temperature) ^c		300	°C		

Notes

a. Repetitive rating; pulse width limited by maximum junction temperature.

b. V_{DD} = 50 V, starting T_J = 25 °C, L = 2.3 mH, R_g = 25 Ω , I_{AS} = 5 A.

c. 1.6 mm from case.

d. $I_{SD} \leq I_D,$ starting T_J = 25 °C.

S16-0109-Rev. B, 25-Jan-16

1





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THERMAL RESISTANCE RATINGS					
PARAMETER	SYMBOL	TYP.	MAX.	UNIT	
Maximum Junction-to-Ambient	R _{thJA}	-	62	°C/W	
Maximum Junction-to-Case (Drain)	R _{thJC}	-	1.2	0/10	

SPECIFICATIONS (T _J = 25 $^{\circ}$ C, u	nless otherw	vise noted)					
PARAMETER	SYMBOL	TEST CONDITIONS		MIN.	TYP.	MAX.	UNIT
Static				•	•		
Drain-Source Breakdown Voltage	V _{DS}	V _{GS} =	= 0 V, I _D = 250 μΑ	500	-	-	V
V _{DS} Temperature Coefficient	$\Delta V_{DS}/T_{J}$	Reference	e to 25 °C, I _D = 250 μA	-	0.58	-	V/°C
Gate-Source Threshold Voltage (N)	V _{GS(th)}	V _{DS} =	= V _{GS} , I _D = 250 μΑ	3	-	5	V
Gate-Source Leakage	I _{GSS}		V _{GS} = ± 30 V	-	-	± 100	nA
Zero Gate Voltage Drain Current	I _{DSS}		= 500 V, V _{GS} = 0 V /, V _{GS} = 0 V, T _J = 125 °C	-	-	1 10	μA
Drain-Source On-State Resistance	R _{DS(on)}	V _{GS} = 10 V		-	1.2	1.5	Ω
Forward Transconductance ^a	9fs		= 20 V, I _D = 2.5 A	-	1.8	-	S
Dynamic	0.0			•			I
Input Capacitance	C _{iss}		V _{GS} = 0 V,	-	325	-	
Output Capacitance	C _{oss}	-	$V_{GS} = 0 V,$ $V_{DS} = 100 V,$	-	34	-	1
Reverse Transfer Capacitance	C _{rss}	-	f = 1 MHz	-	6	-	-
Effective Output Capacitance, Energy Related ^b	C _{o(er)}			-	31	-	pF
Effective Output Capacitance, Time Related ^c	C _{o(tr)}	- V _{DS} = 0	$V_{DS} = 0$ V to 400 V, $V_{GS} = 0$ V		41	-	
Total Gate Charge	Qg			-	10	20	
Gate-Source Charge	Q _{gs}	V _{GS} = 10 V I _D = 2.5 A, V _{DS} = 400 V		-	3	-	nC
Gate-Drain Charge	Q _{gd}	1		-	5	-	1
Turn-On Delay Time	t _{d(on)}		•	-	12	24	
Rise Time	t _r	V _{DD} = 400 V, I _D = 2.5 A		-	11	22	
Turn-Off Delay Time	t _{d(off)}	$R_g =$	9.1 Ω, V _{GS} = 10 V	-	14	28	ns
Fall Time	t _f			-	11	22	1
Gate Input Resistance	Rg	f = 1 MHz, open drain		-	1.7	-	Ω
Drain-Source Body Diode Characteristic	cs			•	•		
Continuous Source-Drain Diode Current	I _S	MOSFET symbol showing the integral reverse P - N junction diode		-	-	5	
Pulsed Diode Forward Current	I _{SM}			-	-	20	A
Diode Forward Voltage	V _{SD}	T _J = 25 °C, I _S = 4 A, V _{GS} = 0 V		-	-	1.2	V
Reverse Recovery Time	t _{rr}			-	320	-	ns
Reverse Recovery Charge	Q _{rr}		T _J = 25 °C, I _F = I _S = 2.5 A, dl/dt = 100 A/μs, V _B = 20 V		1.2	-	μC
Reverse Recovery Current	I _{RRM}		$100 \text{ Av}\mu\text{s}, \text{ v}_{\text{R}} = 20 \text{ v}$	-	8	-	A

Notes

a. Repetitive rating; pulse width limited by maximum junction temperature.

b. C_{oss(er)} is a fixed capacitance that gives the same energy as C_{oss} while V_{DS} is rising from 0 % to 80 % V_{DSS}.

c. $C_{oss(tr)}$ is a fixed capacitance that gives the same charging time as C_{oss} while V_{DS} is rising from 0 % to 80 % V_{DSS} .

2



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TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

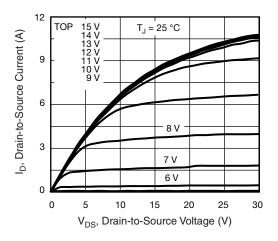


Fig. 1 - Typical Output Characteristics

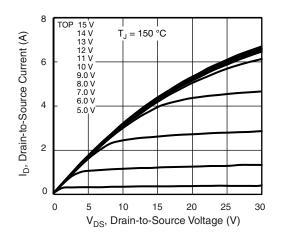


Fig. 2 - Typical Output Characteristics

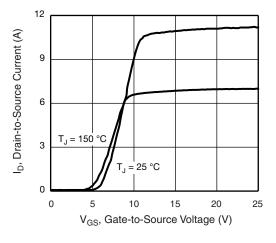


Fig. 3 - Typical Transfer Characteristics

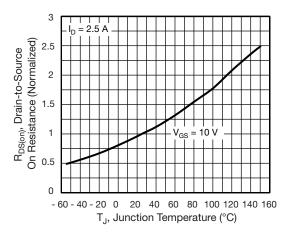


Fig. 4 - Normalized On-Resistance vs. Temperature

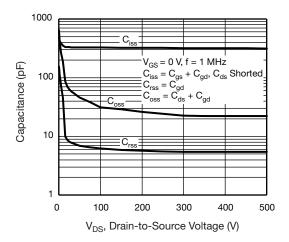


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage

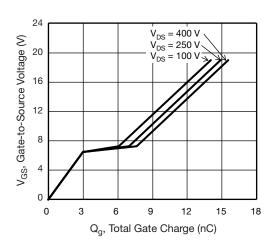


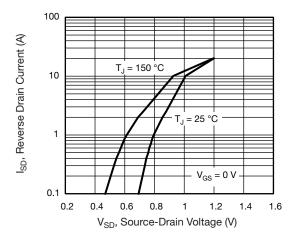
Fig. 6 - Typical Gate Charge vs. Gate-to-Source Voltage

S16-0109-Rev. B, 25-Jan-16

3 echnical questions, contact: hym@visha Document Number: 91520

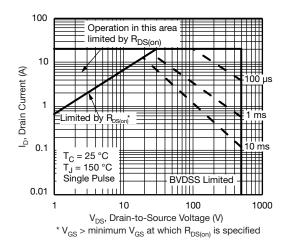
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Fig. 7 - Typical Source-Drain Diode Forward Voltage





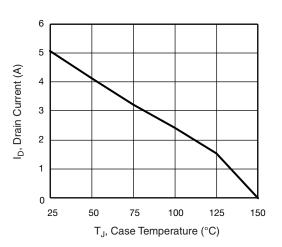


Fig. 9 - Maximum Drain Current vs. Case Temperature

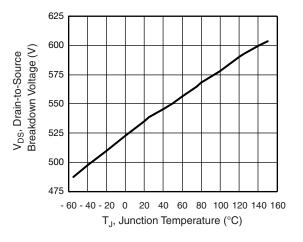
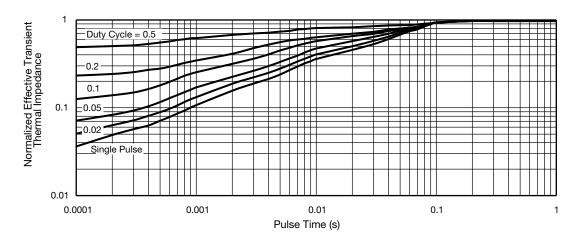


Fig. 10 - Typical Drain-to-Source Voltage vs. Temperature



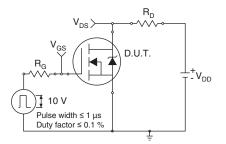


S16-0109-Rev. B, 25-Jan-16

4

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Fig. 12 - Switching Time Test Circuit

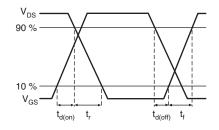


Fig. 13 - Switching Time Waveforms

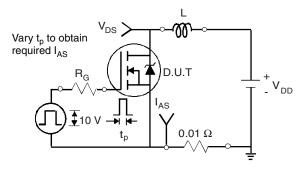


Fig. 14 - Unclamped Inductive Test Circuit

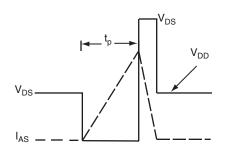


Fig. 15 - Unclamped Inductive Waveforms

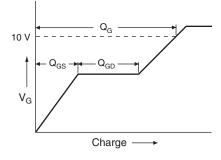


Fig. 16 - Basic Gate Charge Waveform

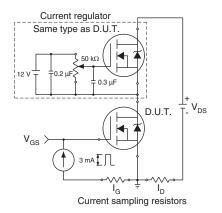
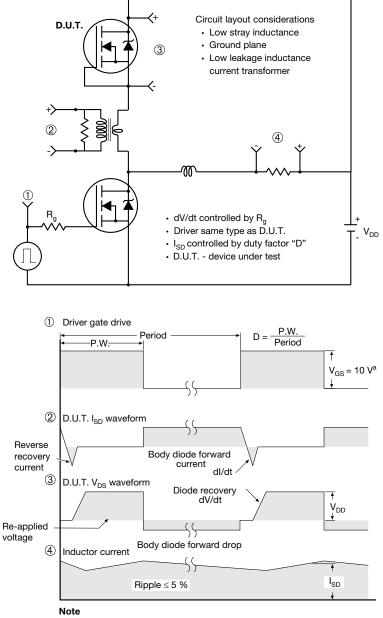


Fig. 17 - Gate Charge Test Circuit

5



Peak Diode Recovery dV/dt Test Circuit



a. $V_{GS} = 5 V$ for logic level devices

Fig. 18 - For N-Channel

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TO-220-1



DIM.	MILLIN	IETERS	INCHES		
DIN.	MIN.	MAX.	MIN.	MAX.	
А	4.24	4.65	0.167	0.183	
b	0.69	1.02	0.027	0.040	
b(1)	1.14	1.78	0.045	0.070	
С	0.36	0.61	0.014	0.024	
D	14.33	15.85	0.564	0.624	
E	9.96	10.52	0.392	0.414	
е	2.41	2.67	0.095	0.105	
e(1)	4.88	5.28	0.192	0.208	
F	1.14	1.40	0.045	0.055	
H(1)	6.10	6.71	0.240	0.264	
J(1)	2.41	2.92	0.095	0.115	
L	13.36	14.40	0.526	0.567	
L(1)	3.33	4.04	0.131	0.159	
ØР	3.53	3.94	0.139	0.155	
Q	2.54	3.00	0.100	0.118	
ECN: X15-0364-Rev. C, 14-Dec-15 DWG: 6031					

Note

- M^{\star} = 0.052 inches to 0.064 inches (dimension including protrusion), heatsink hole for HVM

Package Picture				
AS	ASE		'an	
		IRF 9510 744K AB		

Revison: 14-Dec-15

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